

Discription

The HESDNC3V3B1AF-A protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



DFN1006-2L

Features

- ★ Small Body Outline Dimensions
- ★ Low Body Height
- ★ Peak Power up to 105 Watts @ 8 x 20 μ s Pulse
- ★ Low Leakage current
- ★ Response Time is Typically < 1 ns
- ★ ESD Rating of Class 3 per Human Body Model

10 0 2

Circuit Diagram

Ordering information

| Product ID | Pack | Qty(PCS) |
|-----------------|------------|----------|
| HESDNC3V3B1AF-A | DFN1006-2L | 10000 |

Absolute Ratings (T_{amb}=25°C)

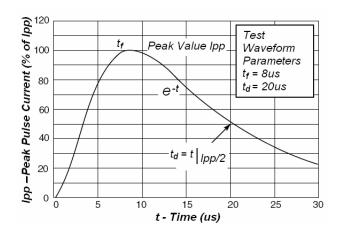
| Symbol | Parameter | Value | Units |
|------------------|--|-------------|-------|
| P _{PP} | Peak Pulse Power ($t_p = 8/20 \mu s$) | 100 | W |
| TL | Maximum lead temperature for soldering during 10s | 260 | °C |
| T _{stg} | Storage Temperature Range | -55 to +150 | °C |
| T _{op} | Operating Temperature Range | | °C |
| T_{j} | Maximum junction temperature | | °C |
| | IEC61000-4-2 (ESD) air discharge contact discharge | ±30 ±30 | KV |
| | IEC61000-4-4 (EFT) | 40 | Α |



Electrical Characteristics

| | V _{RWM} (V) | I _R (μΑ) @ V _{RWM} | V _{BR} (V (Not | | I _T | V _C (V) @ I _{PP} = 1 A (Note 2) | V _C (V) @MAX I _{PP} (Note 2) | I _{PP} (A) (Note 2) | P _{PK} (W) (Note 2) | C (pF) | $R_{DYN}(\Omega)$ $@t_p=100$ $ns(TLP)$ |
|-----------------|-------------------------|---|----------------------------|-----|----------------|---|--|---------------------------------|---------------------------------|--------|--|
| Device | Max | Max | Min | Max | mA | Max | Max | Max | Max | Тур. | Тур. |
| HESDNC3V3B1AF-A | 3.3 | 0.05 | 5 | 6.5 | 1.0 | 7 | 11 | 9 | 100 | 15 | 0.2 |

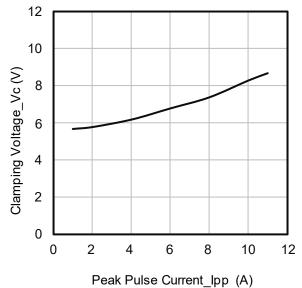
- 1. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25 °C.
- 2. Surge current waveform per Figure 1.

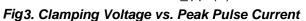


100 90 80 70 % of Rated Power 60 50 Peak Pluse Power 40 8/20µs 30 20 10 25 75 100 125 150 Lead Temperature- $TL(\mathcal{C})$

Fig1. Pulse Waveform

Fig2.Power Derating Curve





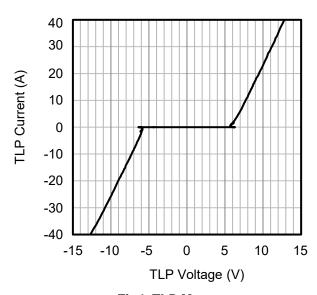
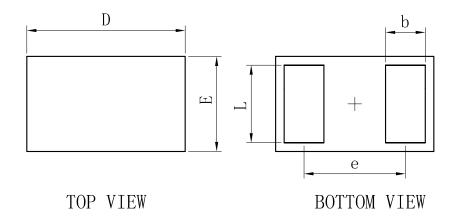


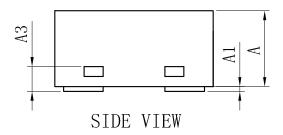
Fig4. TLP Measurement



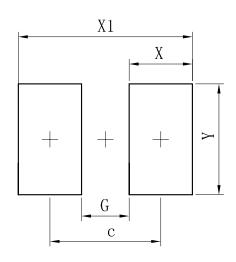
OUTLINE AND DIMENSIONS



| DFN1006-2L | | | | |
|----------------------|------------|-------|-------|--|
| Dim | Min | Тур | Max | |
| D | 0. 95 | 1.00 | 1.05 | |
| Е | 0. 55 | 0.60 | 0.65 | |
| е | _ | 0.64 | - | |
| L | 0.44 | 0.49 | 0. 54 | |
| b | 0. 20 | 0. 25 | 0.30 | |
| A | 0.43 | 0.48 | 0. 53 | |
| A1 | 0 - 0.0 | | | |
| А3 | 0. 127REF. | | | |
| All Dimensions in mm | | | | |



SOLDERING FOOTPRINT



| Dimensions | (mm) |
|------------|------|
| С | 0.70 |
| G | 0.30 |
| X | 0.40 |
| X1 | 1.10 |
| Y | 0.70 |

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